#### Switching Diodes

# **Panasonic**

# MA4X160 (MA160)

### Silicon epitaxial planar type

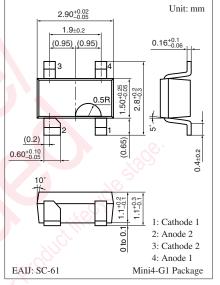
For high-speed switching circuits

#### Features

- Two isolated elements are contained in one package, allowing high-density mounting
- Centrosymmetrical wiring, allowing to free from the taping direction
- Short reverse recovery time  $t_{rr}$
- Small terminal capacitance C<sub>t</sub>

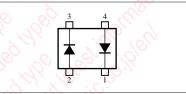
Parameter		Symbol	Rating	Unit
Reverse voltage		V <sub>R</sub>	40	V
Maximum peak reverse voltage		V <sub>RM</sub>	40	V
Forward current	Single	I <sub>F(AV)</sub>	100	mA
(Average)	Series		75	
Repetitive peak	Single	I <sub>FRM</sub>	225	mA
forward current	Series		170	
Non-repetitive peak	Single	I <sub>FSM</sub>	500	mA
forward surge current *	Series		375	
Junction temperature		Tj	150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°C

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$



#### Marking Symbol: M1D

#### Internal Connection



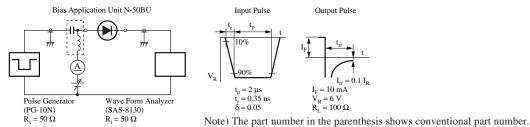
Note) \*: t = 1 s

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 100 mA		0.95	1.20	V
Reverse voltage	V <sub>R</sub>	I <sub>R</sub> = 100 μA	40			V
Reverse current	I <sub>R</sub>	V <sub>R</sub> = 35 V			0.1	μΑ
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$		0.9	2.0	pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$			3	ns
		$I_{\rm rr}$ = 0.1 $I_{\rm R}$ , $R_{\rm L}$ = 100 $\Omega$				

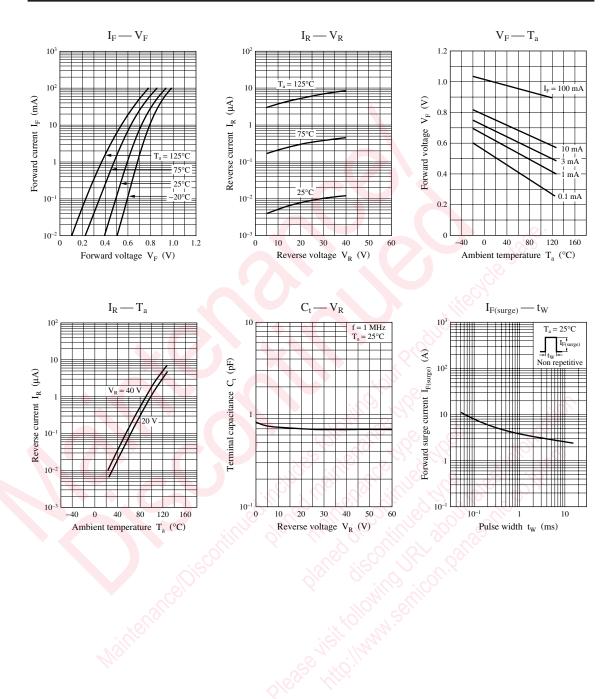
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring method for diodes.

- 2. Absolute frequency of input and output is 100 MHz.
- 3. \*: t<sub>rr</sub> measurement circuit



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